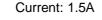
## G2SBA05 THRU G2BA100

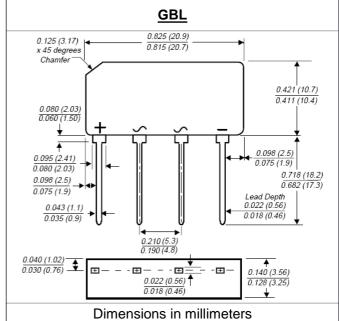
SINGLE PHASE GLASS

Voltage: 50 to 1000V





Features	
Glass passivated chip junction Ideal for printed circuit board High case dielectric strength High surge current capability	
Mechanical Data	
Terminal: Plated leads solderable per MIL-STD 202E, Method 208C	

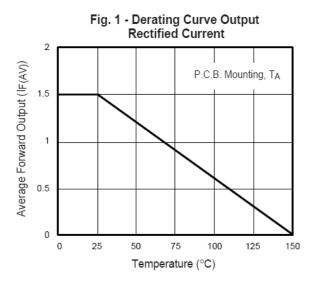


ig F

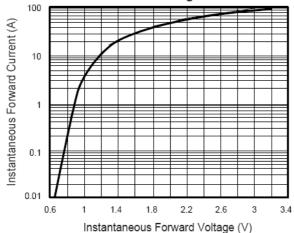
## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (single-phase, half -wave, 60HZ, resistive or inductive load rating at 25°C, unless otherwise stated, for capacitive load, derate current by 20%) G2SB G2SB G2SB G2SB G2SB G2SB G2SB Symbol units A05 A10 A20 A40 A60 A80 A100 Maximum repetitive peak reverse voltage Vrrm 50 100 200 400 600 800 1000 V Maximum RMS voltage Vrms 35 70 V 140 700 280 420 560 Maximum DC blocking voltage Vdc 50 100 200 400 600 800 1000 V Maximum average forward rectified output current lf(av) 1.5 А Ta = 25℃ Peak forward surge current single sine-wave lfsm 60 А superimposed on rated load (JEDEC Method) Maximum instantaneous forward voltage drop per leg at Vf 1.0 V 0.75A l<sup>2</sup>t 15 Rating for fusing (t < 8.3ms) A<sup>2</sup>Sec 5.0 Ta = 25℃ Maximum DC reverse current at ١r μA rated DC blocking voltage per leg Ta = 125℃ 300 40.0 Rth(ja) Maximum thermal resistance per leg °C/W Rth(jc) 12.0 -55 to +150 °C Tj, Tstg Operating junction and storage temperature range Note:

1. Units mounted on P.C.B. with 0.5 x 0.5" (12 x 12mm) copper pads, 0.375" (9.5mm) lead length

## RATINGS AND CHARACTERISTIC CURVES G2SBA05 THRU G2SBA100







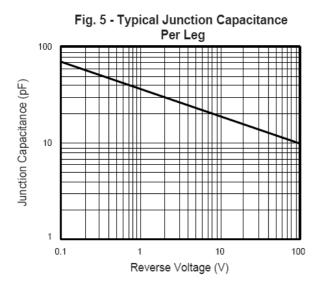


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current Per Leg

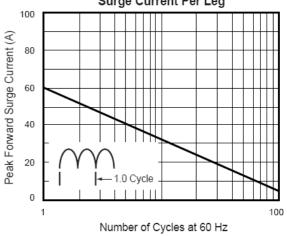


Fig. 4 - Typical Reverse Characteristics

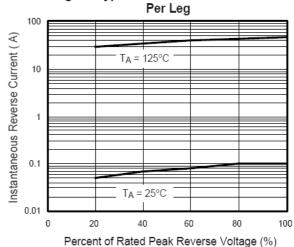


Fig. 6 - Typical Transient Thermal Impedance

